Thin Film, Center-Tapped Resistors



Product may not be to scale

The CTT series resistor chips offer a combination of low shunt capacitance and excellent stability. The CTT offers the designer flexibility in use as either a single value resistor or as two resistor with a center tap feature.

The ČTTs six bonding pads allows the user increased layout flexibility. The CTTs tantalum nitride resistor material offers excellent resistance to high moisture environments.

The CTTs are manufactured using Vishay Electro-Films (EFI) sophisticated thin film equipment and manufacturing technology. The CTTs are 100% electrically tested and visually inspected to MIL-STD-883

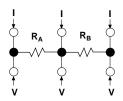
APPLICATIONS

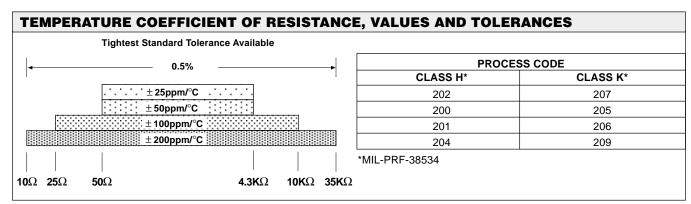
The CTT center-tapped resistor chips are used mainly in feedback circuits of amplifiers where ratio matching, tracking, low shunt capacitance and better frequency response are necessary.

Vishay EFI measures low-value resistors by the four-wire Kelvin technique.

FEATURES

- Center tap feature
- Chip size: 0.030 inches square
- Resistance range R_T: 10Ω to 36kΩ
- Alumina substrate, low shunt capacitance: < 0.2pF
- · Resistor material: tantalum nitride
- Moisture resistant



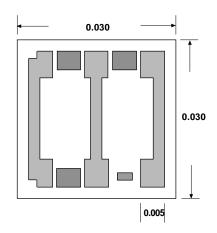


STANDARD ELECTRICAL SPECIFICATIONS					
PARAMETER					
TCR tracking between halves (R _A , R _B)	± 2ppm/°C* 1 ± 1%				
Center tap ratio, R _A /R _B : Tolerance					
Noise, MIL-STD-202, Method 308	- 35dB typical				
Moisture resistance, MIL-STD-202 Method 106	\pm 0.5% maximum Δ R/R				
Stability, 1000 hours, + 125°C, 62mW	\pm 0.25% maximum Δ R/R				
Operating temperature range	- 55°C to + 125°C				
Thermal shock, MIL-STD-202, Method 107, Test condition F	± 0.1% maximum ∆R/R				
High temperature exposure, + 150°C, 100 hours	± 0.2% maximum ΔR/R				
Insulation resistance	10 ¹² minimum				
Operating voltage	100V maximum				
DC power rating at + 70°C (derated to zero at + 150°C)	125mW				
5 x rated power short-time overload, 25°C, 5 seconds	± 0.25% maximum ΔR/R				

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DIMENSIONS in inches



STANDARD CONFIGURATION

*Six locations. All pads 0.005 x 0.005

SCHEMATIC

$$R_{T} = R_{A} + R_{B}$$

$$R_{A}$$

$$R_{B}$$

MECHANICAL SPECIFICATIONS in inches					
PARAMETER					
Chip size	0.030 x 0.030 ± 0.002 (0.762 x 0.762 ± 0.050mm)				
Chip thickness	$0.010 \pm 0.002 \ (0.254 \pm 0.05 \text{mm})$				
Chip substrate material	99.6% Alumina				
Resistor material	Tantalum nitride				
Bonding pad size	0.005 x 0.005 (0.127 x 0.127mm)				
Number of pads	6				
Pad material	25kÅ minimum gold				
Backing	None				

OPTIONS:

Alphanumeric part marking, up to six characters Aluminum bonding pads, 10kÅ minimum

Consult Applications Engineer

ORDERING INFORMATION

Example: 100% visualled, 10kΩ, ± 1%, ± 100ppm/°C TCR, Gold Pads, Class H								
	W = 100% visually insparts per MIL-STD-88 loaded in matrix trays X = Sample, visually inspected loaded in matrix (4% AQL)	33	See Process Code table	Use first 4 significant digits of resistance (R_T)	B = 0.01 A = 0.1 0 = 1 1 = 10 2 = 100 3 = 1000 4 = 10000	D = 0.5% F = 1.0% G = 2.0% H = 2.5% J = 5.0% K = 10% M = 20% L = 25%		

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